



Silicon MELF 500 mW Zener Diodes

Qualified per MIL-PRF-19500/117

Qualified Levels*: JAN, JANTX, and JANTXV

DESCRIPTION

The popular 1N957BUR-1 through 1N992BUR-1 series of 0.5 watt Zener voltage regulators provides a selection from 6.8 to 200 volts in a standard 5%, 2% and 1% tolerance versions. These glass MELF DO-213AA Zeners feature an internal metallurgical bond and are available in military qualified and commercial RoHS compliant versions. Military qualified versions are available on the 1N962BUR-1 through 1N992BUR-1 range of part numbers.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JEDEC registered 1N957B to 1N992B number series.
- Internal metallurgical bond.
- *JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/117 for part numbers 1N962BUR-1 through 1N992BUR-1.
- Upscreening is available in reference to MIL-PRF-19500 for the range of 1N957BUR-1 through 1N961BUR-1. (See <u>part nomenclature</u> for all available options.)
- RoHS compliant versions available (commercial grade only).

APPLICATIONS / BENEFITS

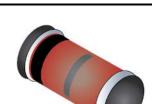
- Regulates voltage over a broad operating current and temperature range.
- Extensive selection from 6.8 to 200 V.
- Standard voltage tolerance is ± 5% with optional tighter tolerances of ± 2% or 1%.
- Small size for high density mounting using the surface mount method (see package illustration).
- Non-sensitive to ESD per MIL-STD-750 method 1020.
- Minimal capacitance.
- Inherently radiation hard as described in Microsemi MicroNote 050.

MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit
Operating and Storage Temperature	T_J and T_{STG}	-65 to +175	٥C
Thermal Resistance Junction-to-End Cap	R _{OJEC}	100	°C/W
Thermal Resistance Junction-to-Ambient when mounted on PCB (1)	R _{OJA}	300	°C/W
Steady-State Power Dissipation @ T _{EC} = +125°C ⁽²⁾ @ T _A = 55°C mounted on PCB	P _D	0.5 0.4	W
Forward Voltage @ I _F = 200 mA 1N957UR - 1N985UR 1N986UR - 1N992UR	V _F	1.1 1.3	V
Solder Temperature @ 10 s	T _{SP}	260	°C

NOTES: 1. See figure 1 for derating curves. T_A = +75°C on an FR4 PC board with 1 oz copper metalization.

2. Derate to 0 at +175°C.



DO-213AA MELF Package

Also available in:

DO-35 (DO-204AH)
package
(axial-leaded)
1N957B-1

1N992B-1

MSC – Lawrence 6 Lake Street,

Lawrence, MA 01841 Tel: 1-800-446-1158 or (978) 620-2600 Fax: (978) 689-0803

MSC - Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

Website:

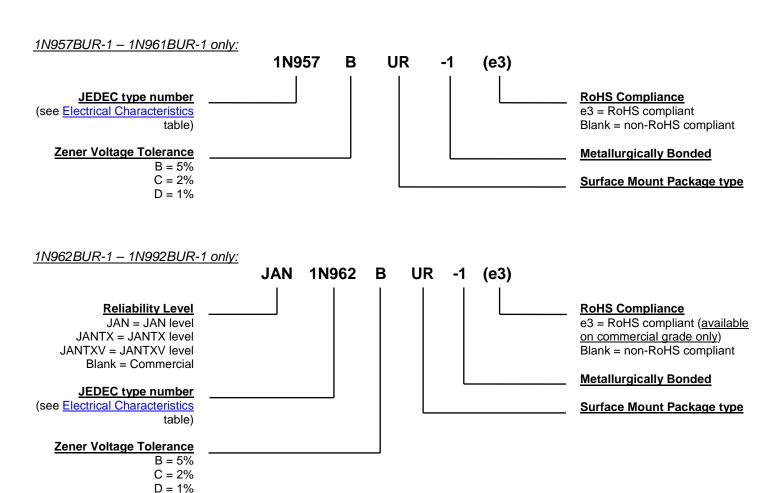
www.microsemi.com



MECHANICAL and PACKAGING

- CASE: Hermetically sealed glass case package.
- TERMINALS: Tin/lead plated or RoHS compliant matte-tin (on commercial grade only) over copper clad steel. Solderable per MIL-STD-750, method 2026.
- POLARITY: Cathode end is banded.
- MOUNTING: The axial coefficient of expansion (COE) of this device is approximately +6PPM/°C. The COE of the mounting surface system should be selected to provide a suitable match with this device.
- MARKING: Part number.
- TAPE & REEL option: Standard per EIA-296. Consult factory for quantities.
- WEIGHT: 0.04 grams.
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE





	SYMBOLS & DEFINITIONS						
Symbol	Definition						
I _R	Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.						
I_Z , I_{ZT} , I_{ZK}	I _Z , I _{ZT} , I _{ZK} Regulator Current: The dc regulator current (I _Z), at a specified test point (I _{ZT}), near breakdown knee (I _{ZK}).						
I _{ZM}	I _{ZM} Maximum Regulator (Zener) Current: The maximum rated dc current for the specified power rating.						
I _{ZSM}	Maximum Zener Surge Current: The non-repetitive peak value of Zener surge current at a specified wave form.						
V _F	V _F Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.						
V _R	V _R Reverse Voltage: The reverse voltage dc value, no alternating component.						
Vz	V _Z Zener Voltage: The Zener voltage the device will exhibit at a specified current (I _Z) in its breakdown region.						
Z_{ZT} or Z_{ZK}	Dynamic Impedance: The small signal impedance of the diode when biased to operate in its breakdown region at a specified rms current modulation (typically 10% of I_{ZT} or I_{ZK}) and superimposed on I_{ZT} or I_{ZK} respectively.						



ELECTRICAL CHARACTERISTICS

JEDEC TYPE NUMBER (NOTE 1)	NOMINAL ZENER VOLTAGE (NOTE 2)	ZENER TEST CURRENT		MUM ZEN PEDANCE Z _{ZT}	Ē	MAXIMUM DC ZENER CURRENT (NOTE 4)	MAXIMUM SURGE CURRENT (NOTE 5)	RE LE CU	XIMUM VERSE AKAGE RRENT	MAXIMUM TEMPERATURE COEFFICIENT
(NOTE I)	٧z	I _{ZT}	\mathbf{Z}_{Z}	\mathbf{Z}_{ZK}	@ I _{zk}	I _{zm}	I _{ZSM}	I _R	@ V _R	$\alpha_{\sf VZ}$
	Volts	mA	Ohms	Ohms	μA	mA	mA	μΑ	Volts	%/°C
1N957BUR-1	6.8	18.5	4.5	700	250	55	300	150	5.2	+0.050
1N958BUR-1	7.5	16.5	5.5	700	250	50	275	75	5.7	+0.058
1N959BUR-1	8.2	15.0	6.5	700	250	45	250	50	6.2	+0.065
1N960BUR-1	9.1	14.0	7.5	700	250	41	225	25	6.9	+0.068
1N961BUR-1	10	12.5	8.5	700	250	38	200	10	7.6	+0.075
1N962BUR-1	11	11.5	9.5	700	250	35	590	1.0	8.4	+0.073
1N963BUR-1	12	10.5	11.5	700	250	32	540	1.0	9.1	+0.076
1N964BUR-1	13	9.5	13.0	700	250	30	500	0.5	9.9	+0.079
1N965BUR-1	15	8.5	16	700	250	26	433	0.5	11	+0.082
1N966BUR-1	16	7.8	17	700	250	25	406	0.5	12	+0.083
1N967BUR-1	18	7.0	21	750	250	21	361	0.5	14	+0.085
1N968BUR-1	20	6.2	25	750	250	19	325	0.5	15	+0.086
1N969BUR-1	22	5.6	29	750	250	17	295	0.5	17	+0.087
1N970BUR-1	24	5.2	33	750	250	16	271	0.5	18	+0.088
1N971BUR-1	27	4.6	41	750	250	14	240	0.5	21	+0.090
1N972BUR-1	30	4.2	49	1000	250	13	216	0.5	23	+0.091
1N973BUR-1	33	3.8	58	1000	250	12	197	0.5	25	+0.092
1N974BUR-1	36	3.4	70	1000	250	11	180	0.5	27	+0.093
1N975BUR-1	39	3.2	80	1000	250	9.1	166	0.5	30	+0.094
1N976BUR-1	43	3.0	93	1000	250	8.8	151	0.5	33	+0.095
1N977BUR-1	47	2.7	105	1500	250	7.9	138	0.5	36	+0.095
1N978BUR-1	51	2.5	125	1500	250	7.4	127	0.5	39	+0.096
1N979BUR-1	56	2.2	150	2000	250	6.9	116	0.5	43	+0.096
1N980BUR-1	62	2.0	185	2000	250	6.0	105	0.5	47	+0.097
1N981BUR-1	68	1.8	230	2000	250	5.5	95	0.5	52	+0.097
1N982BUR-1	75	1.7	270	2000	250	5.1	86	0.5	56	+0.098
1N983BUR-1	82	1.5	330	3000	250	4.6	79	0.5	62	+0.098
1N984BUR-1	91	1.4	400	3000	250	4.2	71	0.5	69	+0.099
1N985BUR-1	100	1.3	500	3000	250	3.7	65	0.5	76	+0.110
1N986BUR-1	110	1.1	750	4000	250	3.3	59	0.5	84	+0.110
1N987BUR-1	120	1.0	900	4500	250	3.1	54	0.5	91	+0.110
1N988BUR-1	130	0.95	1100	5000	250	2.7	50	0.5	99	+0.110
1N989BUR-1	150	0.85	1500	6000	250	2.4	43	0.5	114	+0.110
1N990BUR-1	160	0.80	1700	6500	250	2.2	40	0.5	122	+0.110
1N991BUR-1	180	0.68	2200	7100	250	2.0	36	0.5	137	+0.110
1N992BUR-1	200	0.65	2500	8000	250	1.8	32	0.5	152	+0.110

NOTES:

- 1 The JEDEC type numbers shown (B suffix) have a ± 5% tolerance on nominal Zener voltage. The suffix C will have ± 2% tolerance; and suffix D will have ± 1% tolerance.
- Zener voltage (V_Z) is measured after the test current has been applied for 20 ± 5 seconds. Mounting clips shall be maintained at temperature of 25 ± 8/ 2 °C.
- The Zener impedance is derived when a 60 cycle ac current having an rms value equal to 10% of the dc Zener current (I_{ZT} or I_{ZK}) is superimposed on I_{ZT} or I_{ZK}. Zener impedance is measured at 2 points to ensure a sharp knee on the breakdown curve and to eliminate unstable units. See MicroNote 202 for variation in dynamic impedance with different Zener currents.
- The values of I_{ZM} are calculated for a ± 5% tolerance on nominal Zener voltage. Allowance has been made for the rise in Zener voltage above V_{ZT} which results from Zener impedance and the increase in junction temperature as power dissipation approaches 400 mW. In the case of individual diodes I_{ZM} is that value of current which results in a dissipation of 400 mW at 75°C lead temperature at 3/8" from body.
- 5 The surge for I_{ZSM} is a square wave or equivalent half-sine wave pulse of 1/120 sec. duration.



GRAPHS

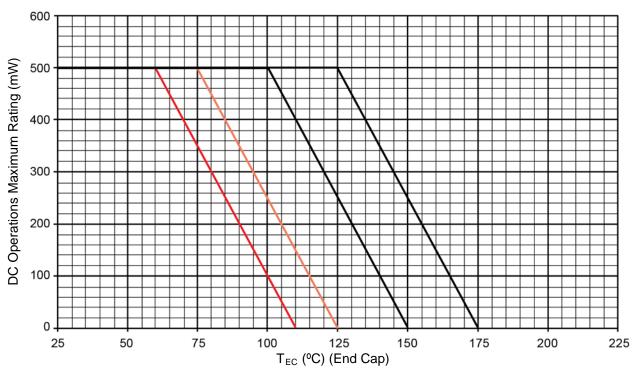


FIGURE 1
Temperature-Power Derating Curve

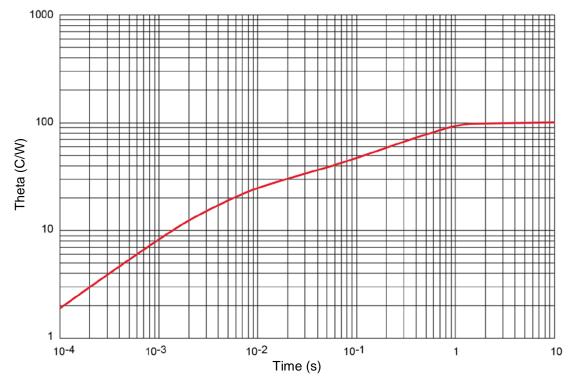
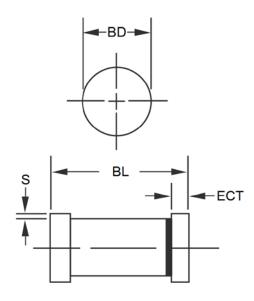


FIGURE 2
Thermal Impedance



PACKAGE DIMENSIONS

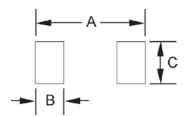


DIM	INC	CH	MILLIMETERS		
DIIVI	MIN	MAX	MIN	MAX	
BD	0.063	0.067	1.60	1.70	
BL	0.130	0.146	3.30	3.71	
ECT	0.016	0.022	0.41	0.56	
S	0.001	-	0.03	-	

NOTES:

- 1. Dimensions are in inches. Millimeters are given for general information only.
- 2. Dimensions are pre-solder dip.
- 3. Referencing to dimension S, minimum clearance of glass body to mounting surface on all orientations.
- 4. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.

PAD LAYOUT



	INCH	mm
Α	.200	5.08
В	.055	1.40
С	.080	2.03